

ITG-100AI

Fanless Ultra Compact Size AI Embedded System



Features

- » Intel®Atom™ x5-E3930 1.3GHz (up to 1.8 GHz)
- » Two GbE LAN ports
- » Two RS-232/422/485
- » M.2 A-key slot for WiFi Module
- » Pre-installed Mustang-MPCI-E-MX2, 2 x Intel Myriad X VPU for AI deep learning workload consolidation

Specifications

Form factor	
SBC Form Factor	» CPU:
	Intel® Atom™ x5-E3930 1.3GHz (up to 1.8 GHz, dual core, TDP=6.5W)
	» Chipset:
	SoC
	» System Memory:
	1x 204-pin DDR3L SO-DIMM slot pre-installed with 8 GB memory
	» Power:
	Input : 2-pin terminal block: 9~36V DC-in
	» Reliability:
	Operating Shock: Half-sine wave shock 5G, 11ms, 100 shocks per axis, IEC68-2-27
	Operating Vibration: MIL-STD-810G 514.6C-1
	Safety/EMC: CE/FCC
I/O Interface	
I/O Ports	» USB: 2 x USB 3.0
	» Ethernet: 2 x RJ-45 PCIe GbE by Intel® I211 controller
	» COM Port: 2 x RS-232/422/485 (DB-9/RJ45)
	» Display: 1 x VGA
Expansion Slots	
Expansion Slots	M.2:
	1 x M.2 A key 2230 (PCIe by 1, USB2.0)
	PCIe Mini:
	Pre-installed Mustang-MPCI-E-MX2
System	
Cooling method / System Fan	Fanless
Drive Bays	SATADOM: Pre-installed 128GB
	eMMC: 1 x eMMC 5.0 support (up to 32GB optional)
	Micro SD: 1 x Micro SD Slot
Indicator&Buttons	

Buttons	1 x Power Button
	1 x Reset Button
	1 x AT/ATX Switch
Indicators	1 x LED for HDD (Yellow)
	1 x LED for Power (Green)
Physical Characteristics	
Construction	Extruded aluminum alloy
Color	
Color	Blue & Silver
Dimensions	
Dimensions	137 x 102.8 x 49.4 (WxDxH) (mm)
Environment	
Operating Temperature	-20°C ~ 50°C with air flow
Humidity	10% ~ 95%, non-condensing

Ordering Information

ITG-100AI-E1/8GB/S-R10	Fanless embedded system, Intel®Apollo Lake x5-E3930 1.3GHz (up to 1.8GHz, dual core), 8GB DDR3L pre-installed memory, VGA, M.2, COM, 9-36V DC, Mustang-MPCIE-MX2 and RoHS
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Packing List

1x 36w Adapter	1x Power Cable
1x Power Cord	1 x Screw kit
1 x Din-rail mounting bracket	1 x RJ-45 to DB-9 COM port cable